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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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40V P-Channel PowerTrench® MOSFET

General Description

This P.Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V - 20V).

Applications

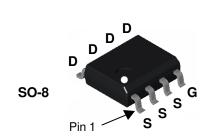
- Power management
- · Load switch
- Battery protection

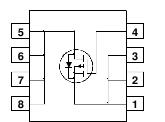
Features

• -11 A, -40 V
$$R_{DS(ON)} = 0.013 \ \Omega \ @ V_{GS} = -10 \ V$$

 $R_{DS(ON)} = 0.017 \ \Omega \ @ V_{GS} = -4.5 \ V$

- Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-40	V
V _{GSS}	Gate-Source Voltage		±20	V
l _D	Drain Current – Continuous	(Note 1a)	-11	Α
	– Pulsed		50	
PD	Power Dissipation for Single Operation	(Note 1a)	2.4 (steady state)	W
		(Note 1b)	1.4	
		(Note 1c)	1.2	
T_J, T_{STG}	Operating and Storage Junction Temperatu	ure Range	-55 to +175	°C
Therma	I Characteristics			
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	62.5 (steady state), 50 (10 sec)	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Device Marking	Device	Reel Size	Tape width	Quantity
FDS4675	FDS4675	13"	12mm	2500 units

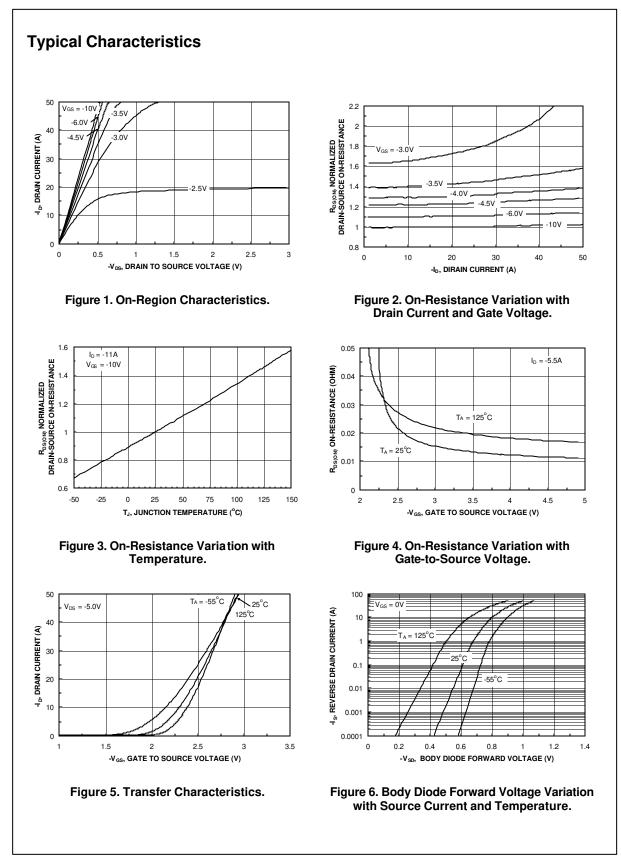
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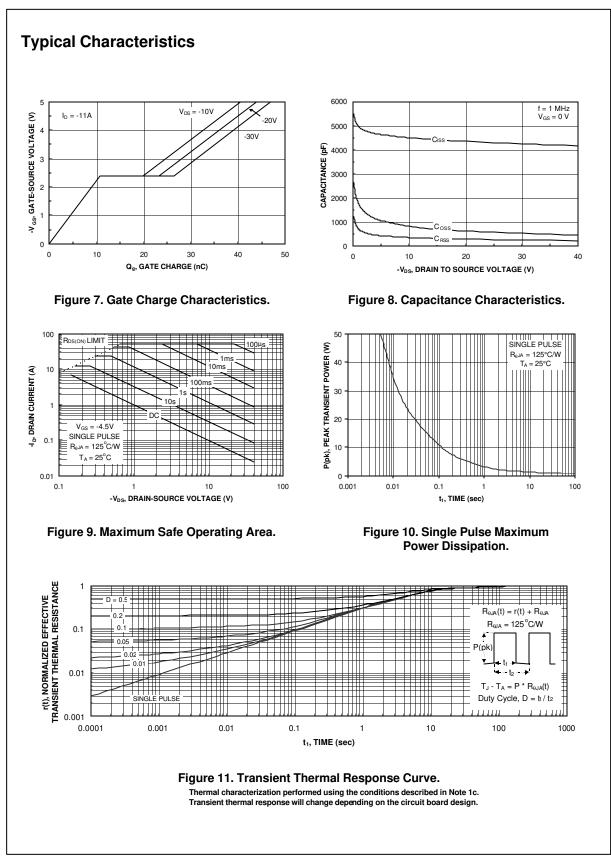
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	I				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-40			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-34		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -32 V$, $V_{GS} = 0 V$			-1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -20 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.4	-3	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		4.6		mV/⁰C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = -10 \ V, & l_D = -11 \ A \\ V_{GS} = -4.5 \ V, & l_D = -9.5 \ A \\ V_{GS} = -10 \ V, \ l_D = -11 \ A, \ T_J = 125^\circ C \end{array} $		10 13 15	13 17 21	mΩ
D(on)	On-State Drain Current	$V_{GS} = -10 V$, $V_{DS} = -5 V$	-25			Α
g fs	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -11 A$		44		S
Dvnamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -20 V$, $V_{GS} = 0 V$,		4350		pF
Coss	Output Capacitance	f = 1.0 MHz		622		pF
C _{rss}	Reverse Transfer Capacitance			290		pF
Switchir	g Characteristics (Note 2)	•			•	
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -20 V$, $I_D = -1 A$,		20	36	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		29	46	ns
t _{d(off)}	Turn-Off Delay Time			95	152	ns
t _f	Turn–Off Fall Time			60	96	ns
Qg	Total Gate Charge	$V_{DS} = -20 V$, $I_D = -11 A$,		40	56	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		11		nC
	Gate-Drain Charge			13		nC
Q _{gd}						
Q _{gd} Drain–Se	ource Diode Characteristics	and Maximum Ratings				
0	ource Diode Characteristics				-2.1	А

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDS4675 Rev C(W)





FDS4675 Rev C(W)

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